

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

**description**

The '279 offers 4 basic  $\bar{S}$ - $\bar{R}$  flip-flop latches in one 16-pin, 300-mil package. Under conventional operation, the  $\bar{S}$ - $\bar{R}$  inputs are normally held high. When the  $\bar{S}$  input is pulsed low, the  $Q$  output will be set high. When  $\bar{R}$  is pulsed low, the  $Q$  output will be reset low. Normally, the  $\bar{S}$ - $\bar{R}$  inputs should not be taken low simultaneously. The  $Q$  output will be unpredictable in this condition.

**FUNCTION TABLE  
(each latch)**

INPUTS		OUTPUT
$\bar{S}_1$	$\bar{R}$	$Q$
H	H	$Q_0$
L	H	H
H	L	L
L	L	H <sup>†</sup>

H = high level      L = low level

<sup>†</sup>For latches with double S inputs:

$Q_0$  = the level of  $Q$  before the indicated input conditions were established.

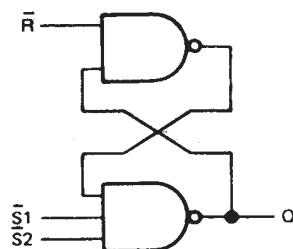
<sup>‡</sup>This configuration is nonstable: that is, it may not persist when the  $\bar{S}$  and  $\bar{R}$  inputs return to their inactive (high) level.

H = both  $\bar{S}$  inputs high

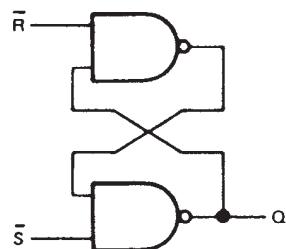
L = one or both  $\bar{S}$  inputs low

**logic diagram (positive logic)**

**(latches 1 and 3)**



**(latches 2 and 4)**

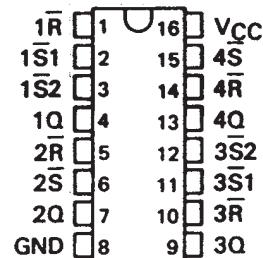


SN54279, SN54LS279A . . . J OR W PACKAGE

SN74279 . . . N PACKAGE

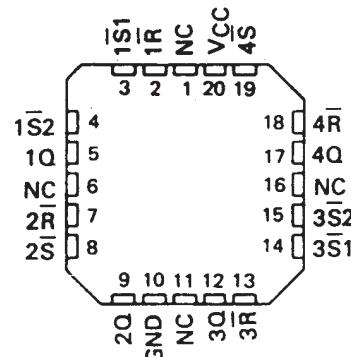
SN74LS279A . . . D OR N PACKAGE

(TOP VIEW)



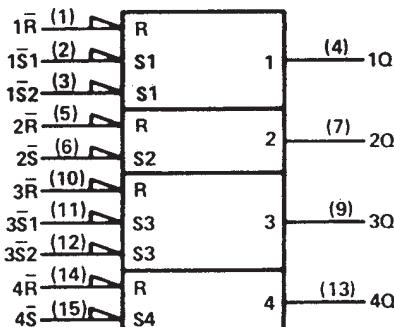
SN54LS279A . . . FK PACKAGE

(TOP VIEW)



NC - No internal connection

**logic symbol<sup>§</sup>**



<sup>§</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

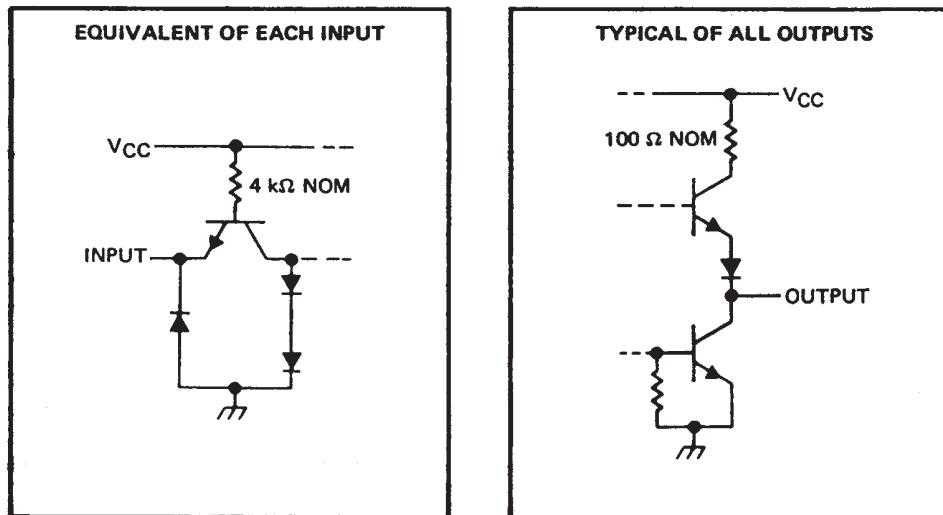
Pin numbers shown are for D, J, N, and W packages.

# SN54279, SN54LS279A, SN74279, SN74LS279A QUADRUPLE S-R LATCHES

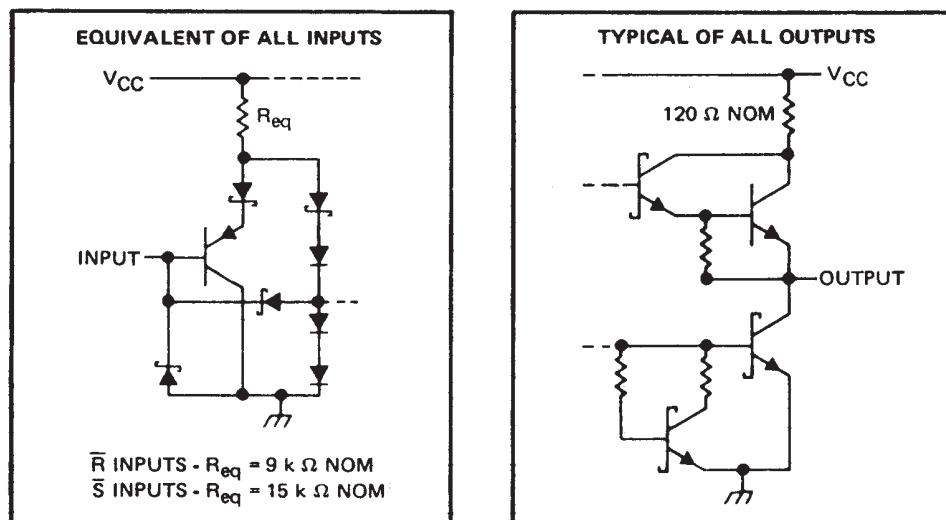
SDLS093 – DECEMBER 1983 – REVISED MARCH 1988

## **schematics of inputs and outputs**

## '279 CIRCUITS



## 'LS279A CIRCUITS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

NOTE 1: Voltage values are with respect to network ground terminal.



# SN54279, SN54LS279A, SN74279, SN74LS279A QUADRUPLE S-R LATCHES

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## recommended operating conditions

		SN54279			SN74279			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
$V_{IH}$	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
$I_{OH}$	High-level output current			-0.8			-0.8	mA
$I_{OL}$	Low-level output current			16			16	mA
$t_w$	Pulse duration, low	20			20			ns
$T_A$	Operating free-air temperature	-55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>†</sup>	SN54279			SN74279			UNIT
		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	
$V_{IK}$	$V_{CC} = \text{MIN}$ , $I_I = -12 \text{ mA}$			-1.5			-1.5	V
$V_{OH}$	$V_{CC} = \text{MIN}$ , $V_{IL} = 0.8 \text{ V}$ , $I_{OH} = -0.8 \text{ mA}$	2.4	3.4		2.4	3.4		V
$V_{OL}$	$V_{CC} = \text{MIN}$ , $V_{IH} = 2 \text{ V}$ , $I_{OL} = 16 \text{ mA}$	0.2	0.4		0.2	0.4		V
$I_I$	$V_{CC} = \text{MAX}$ , $V_I = 5.5 \text{ V}$			1			1	mA
$I_{IH}$	$V_{CC} = \text{MAX}$ , $V_I = 2.4 \text{ V}$			40			40	μA
$I_{IL}$	$V_{CC} = \text{MAX}$ , $V_I = 0.4 \text{ V}$			-1.6			-1.6	mA
$I_{OS}^§$	$V_{CC} = \text{MAX}$	-18	-55		-18	-57		mA
$I_{CC}$	$V_{CC} = \text{MAX}$ , See Note 2	18	30		18	30		mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time.

NOTE 2:  $I_{CC}$  is measured with all R inputs grounded, all S inputs at 4.5 V, and all outputs open.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^\circ\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PLH}$	$\bar{S}$	Q	$R_L = 400 \Omega$ , $C_L = 15 \text{ pF}$	12	22		ns
$t_{PHL}$				9	15		
$t_{PHL}$				15	27		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

# SN54279, SN54LS279A, SN74279, SN74LS279A QUADRUPLE S-R LATCHES

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## recommended operating conditions

		SN54LS279A			SN74LS279A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V <sub>IH</sub>	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.7			0.8	V
I <sub>OH</sub>	High-level output current			–0.4			–0.4	mA
I <sub>OL</sub>	Low-level output current			4			8	mA
t <sub>w</sub>	Pulse duration, low	20			20			ns
T <sub>A</sub>	Operating free-air temperature	–55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>†</sup>	SN54LS279A			SN74LS279A			UNIT
		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	
V <sub>IK</sub>	V <sub>CC</sub> = MIN, I <sub>I</sub> = –18 mA			–1.5			–1.5	V
V <sub>OH</sub>	V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, I <sub>OH</sub> = –0.4 mA	2.5	3.4		2.7	3.4		V
V <sub>OL</sub>	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	
	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 8 mA				0.25	0.5		V
I <sub>I</sub>	V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V			0.1			0.1	mA
I <sub>IH</sub>	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V			20			20	μA
I <sub>IL</sub>	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V			–0.2			–0.2	mA
I <sub>OS</sub> <sup>§</sup>	V <sub>CC</sub> = MAX	–20		–100	–20		–100	mA
I <sub>CC</sub>	V <sub>CC</sub> = MAX, See note 2		3.8	7		3.8	7	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should be less than one second.

NOTE 2: I<sub>CC</sub> is measured with all R inputs grounded, all S inputs at 4.5 V, and all outputs open.

## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	S	Q	R <sub>L</sub> = 2 kΩ, C <sub>L</sub> = 15 pF	12	22		
t <sub>PHL</sub>				13	21		ns
t <sub>PHL</sub>				15	27		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
76018012A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76018012A SNJ54LS 279AFK
7601801EA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
7601801EA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
7601801FA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW
7601801FA	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW
SN54LS279AJ	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS279AJ
SN54LS279AJ	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS279AJ
SN54LS279AJ.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS279AJ
SN54LS279AJ.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS279AJ
SN74LS279AD	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	0 to 70	LS279A
SN74LS279AD	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	0 to 70	LS279A
SN74LS279ADR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS279A
SN74LS279ADR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS279A
SN74LS279ADR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS279A
SN74LS279ADR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS279A
SN74LS279AN	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279AN	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279AN.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279AN.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279ANE4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279ANE4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS279AN
SN74LS279ANSR	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS279A
SN74LS279ANSR	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS279A
SN74LS279ANSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS279A
SN74LS279ANSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS279A

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SNJ54LS279AFK	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76018012A SNJ54LS 279AFK
SNJ54LS279AFK	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76018012A SNJ54LS 279AFK
SNJ54LS279AFK.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76018012A SNJ54LS 279AFK
SNJ54LS279AFK.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76018012A SNJ54LS 279AFK
SNJ54LS279AJ	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
SNJ54LS279AJ	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
SNJ54LS279AJ.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
SNJ54LS279AJ.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801EA SNJ54LS279AJ
SNJ54LS279AW	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW
SNJ54LS279AW	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW
SNJ54LS279AW.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW
SNJ54LS279AW.A	Active	Production	CFP (W)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601801FA SNJ54LS279AW

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LS279A, SN74LS279A :**

- Catalog : [SN74LS279A](#)
- Military : [SN54LS279A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

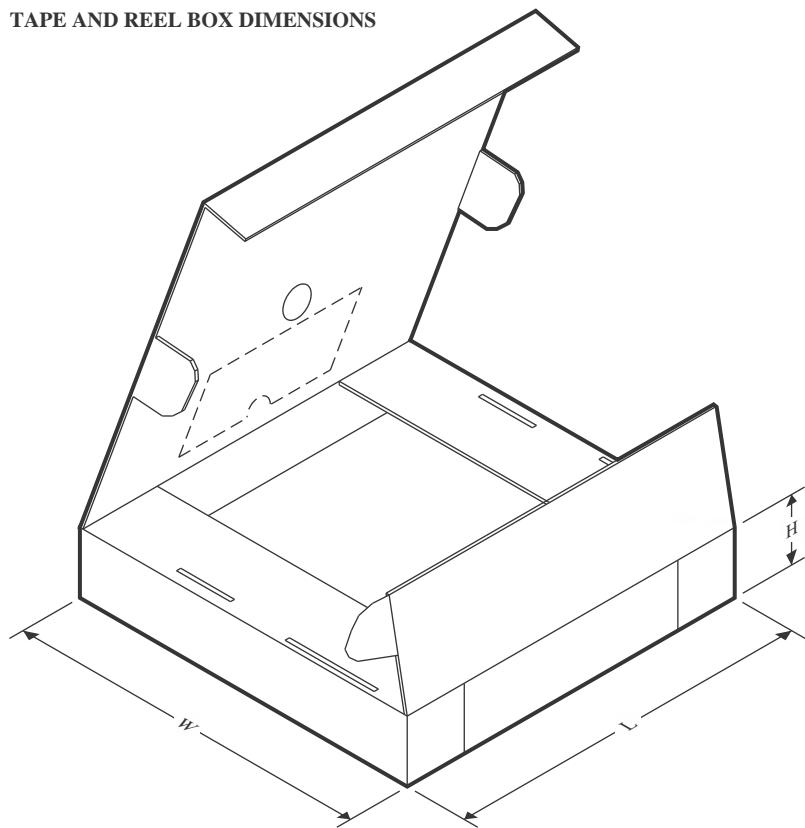
**TAPE AND REEL INFORMATION**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

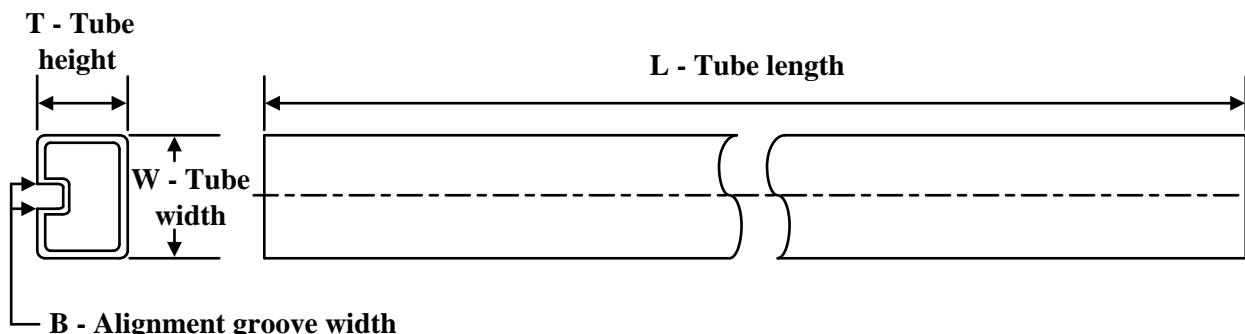

\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS279ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS279ANSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS279ADR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS279ANSR	SOP	NS	16	2000	353.0	353.0	32.0

**TUBE**


\*All dimensions are nominal

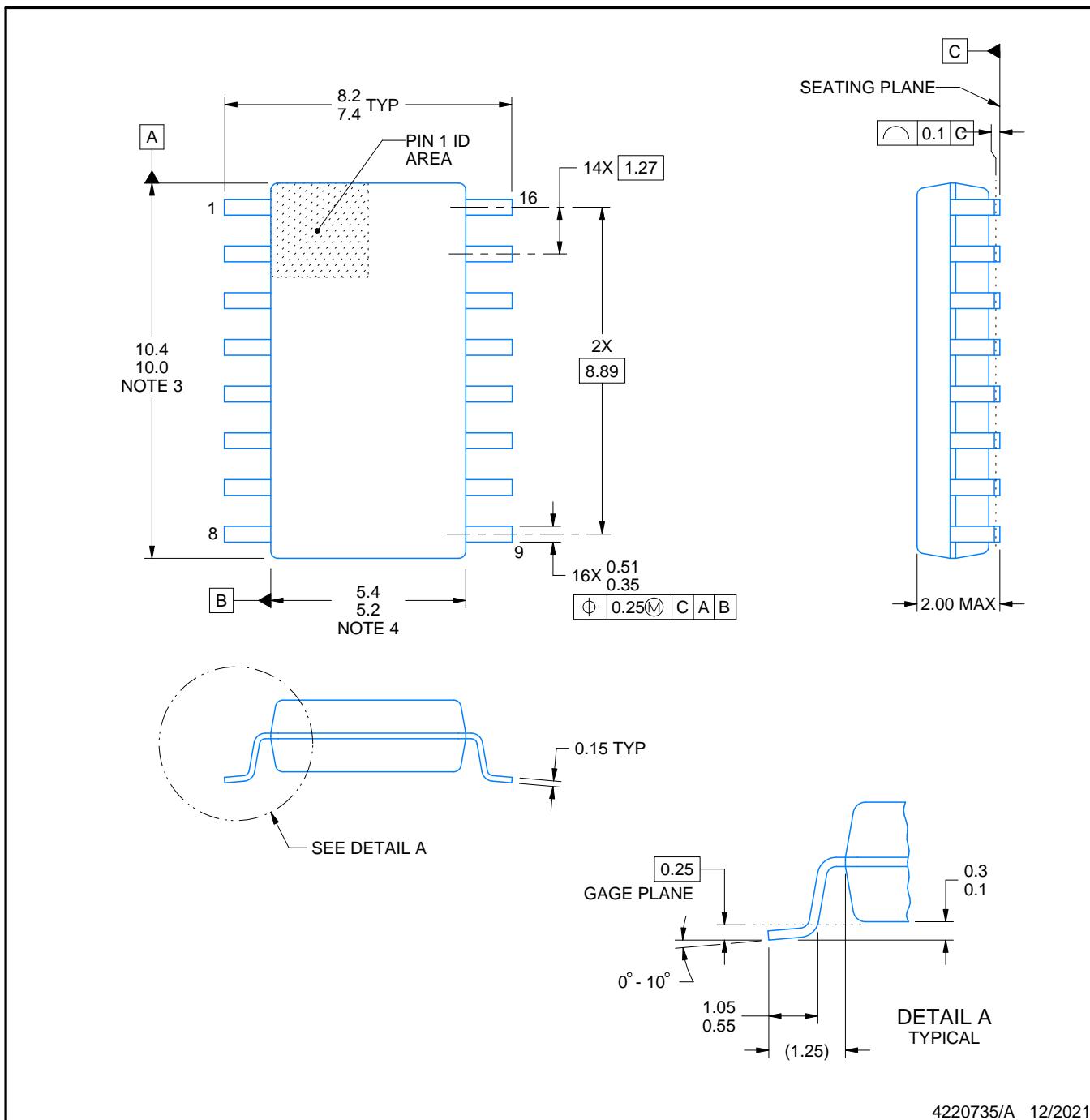
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
76018012A	FK	LCCC	20	55	506.98	12.06	2030	NA
7601801FA	W	CFP	16	25	506.98	26.16	6220	NA
SN74LS279AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS279AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS279AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS279AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS279ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS279ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS279AFK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS279AFK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS279AW	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS279AW.A	W	CFP	16	25	506.98	26.16	6220	NA



# PACKAGE OUTLINE

## SOP - 2.00 mm max height

SOP



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### NOTES:

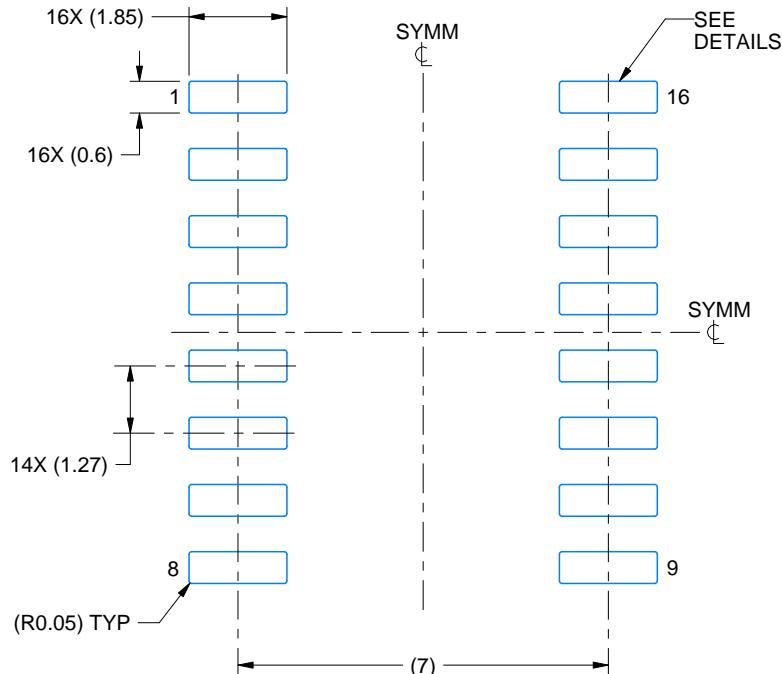
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

# EXAMPLE BOARD LAYOUT

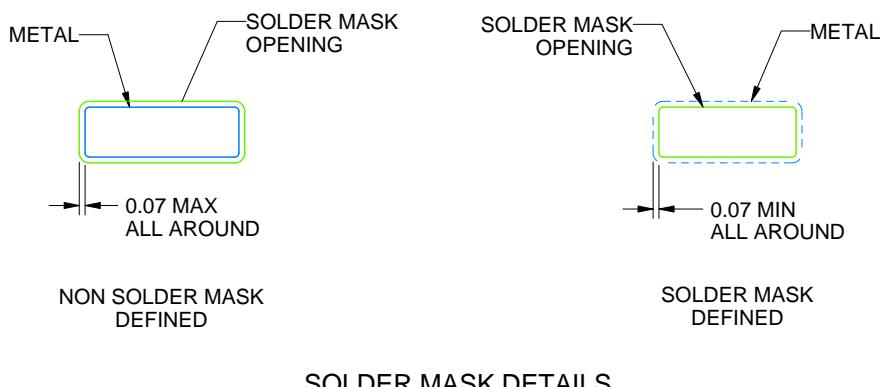
NS0016A

SOP - 2.00 mm max height

SOP



LAND PATTERN EXAMPLE  
SCALE:7X



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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

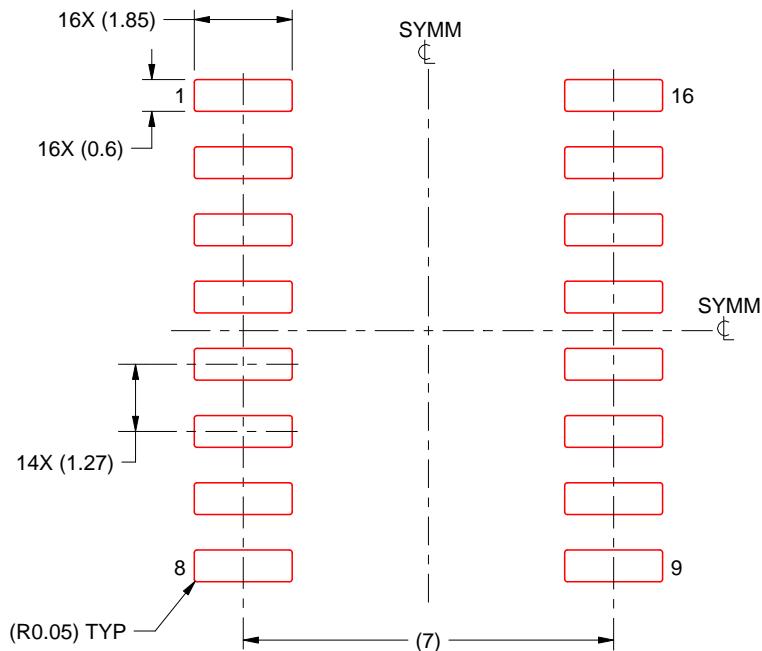
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:7X

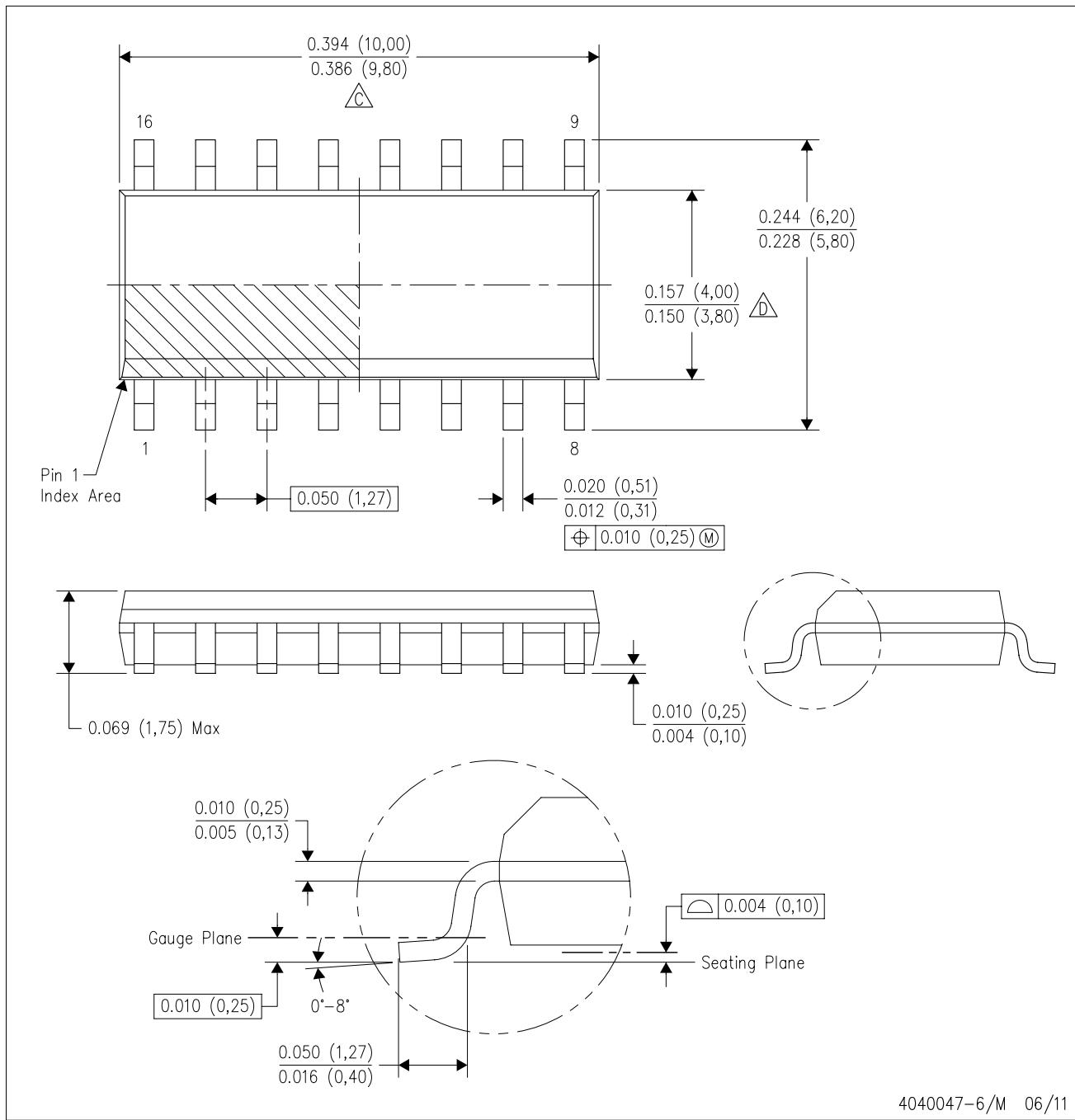
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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

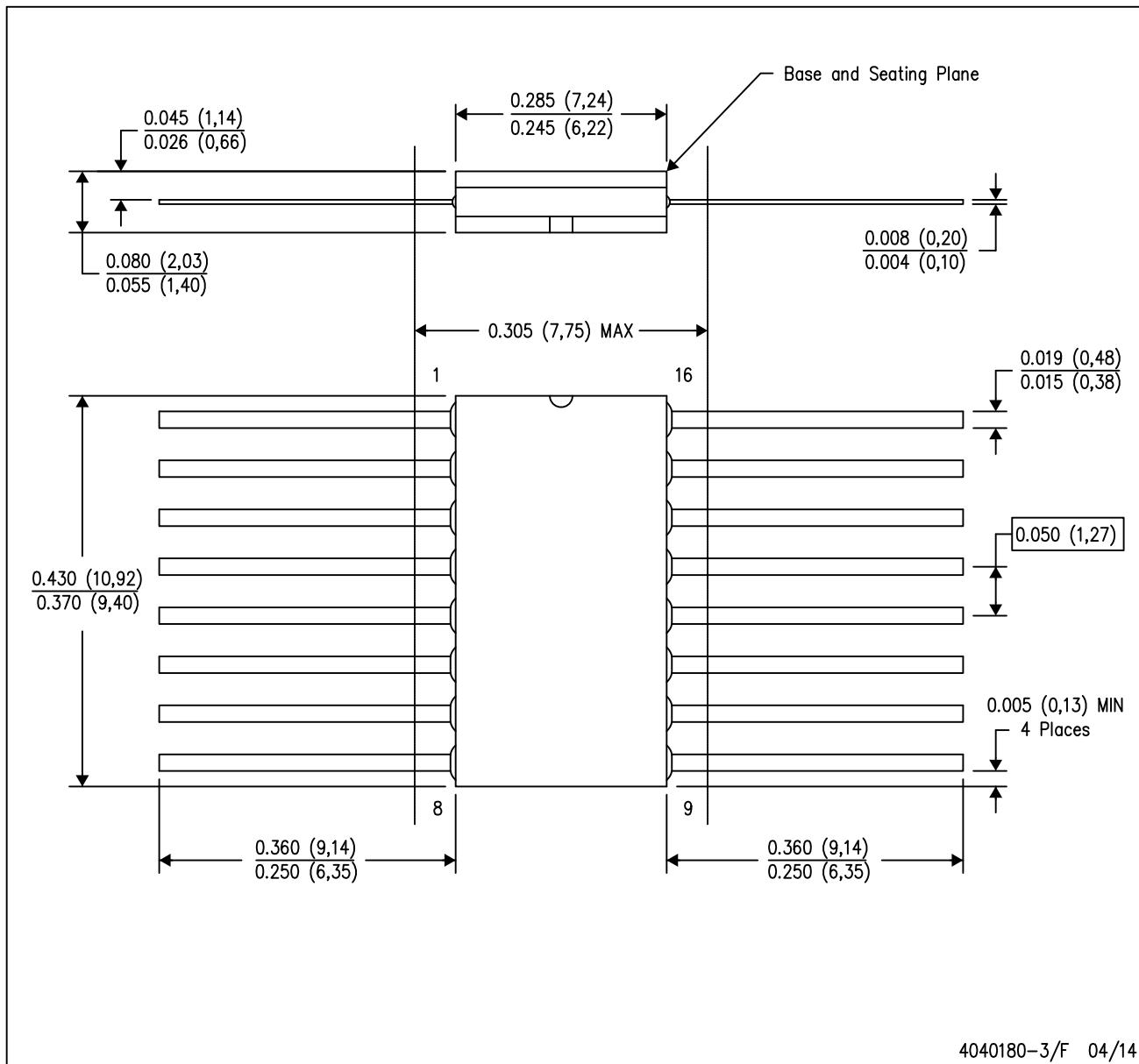
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.

D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.

E. Reference JEDEC MS-012 variation AC.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL-STD 1835 GDFP2-F16

# GENERIC PACKAGE VIEW

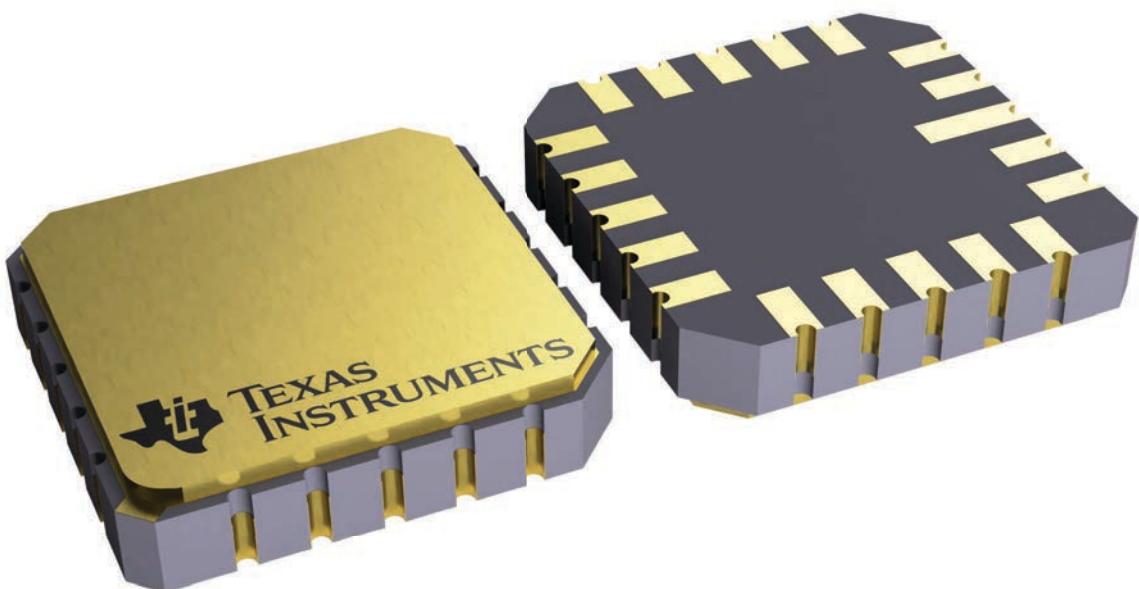
**FK 20**

**LCCC - 2.03 mm max height**

**8.89 x 8.89, 1.27 mm pitch**

**LEADLESS CERAMIC CHIP CARRIER**

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

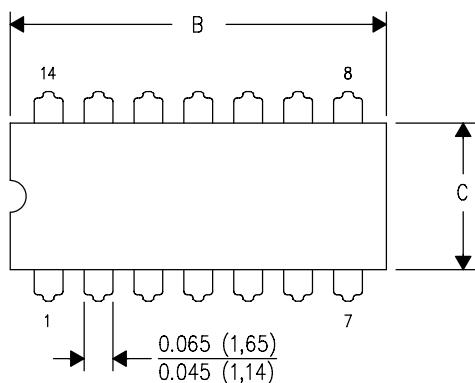


4229370VA\

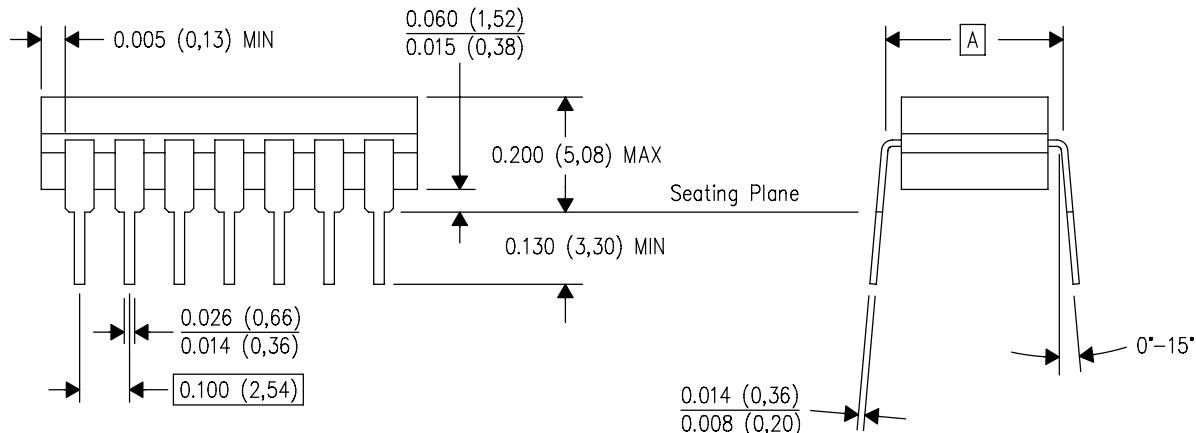
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



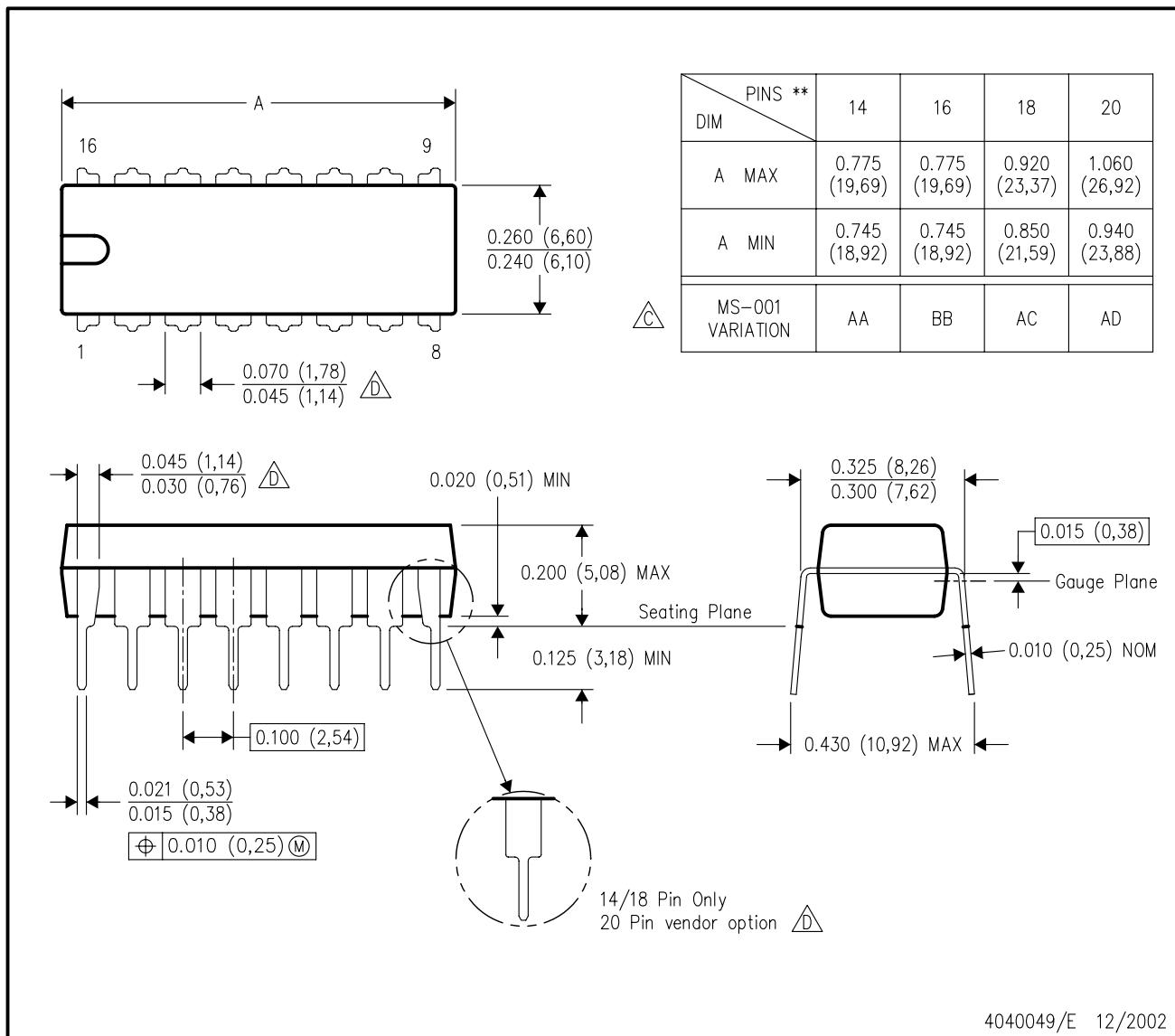
4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. This package is hermetically sealed with a ceramic lid using glass frit.  
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.  
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.

△ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

△ The 20 pin end lead shoulder width is a vendor option, either half or full width.

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